2SC3935

Silicon NPN epitaxial planer type

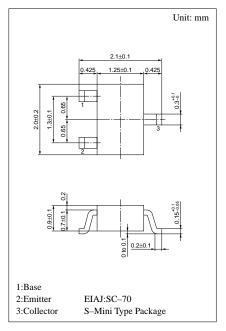
For high-frequency amplification/oscillation/mixing

Features

- High transition frequency f_T.
- ullet Small collector output capacitance C_{ob} and common base reverse transfer capacitance C_{rb} .
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	15	V
Collector to emitter voltage	V_{CEO}	10	V
Emitter to base voltage	V _{EBO}	3	V
Collector current	I_{C}	50	mA
Collector power dissipation	P_{C}	150	mW
Junction temperature	T _j	150	°C
Storage temperature	T_{stg}	−55 ~ +150	°C



Marking symbol: 1S

■ Electrical Characteristics (Ta=25°C)

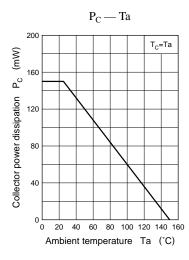
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = 10V, I_{E} = 0$			1	μΑ
	I _{CEO}	$V_{CE} = 10V, I_{B} = 0$			10	μΑ
Collector to emitter voltage	V _{CEO}	$I_C = 2mA, I_B = 0$	10			V
Emitter to base voltage	V _{EBO}	$I_{\rm E} = 10 \mu A, I_{\rm C} = 0$	3			V
Forward current transfer ratio	h _{FE1}	$V_{CE} = 2.4V, I_C = 7.2mA$	75		220	
	h _{FE2}	$V_{CE} = 2.4 \text{V}, I_{C} = 100 \mu\text{A}$	75			
Collector to emitter saturation voltage	V _{CE(sat)}	$I_C = 20\text{mA}, I_B = 4\text{mA}$			0.5	V
Transition frequency	f_T	$V_{CE} = 2.4V, I_C = 7.2mA, f = 200MHz$	1.4	1.9	2.5	GHz
Collector output capacitance	C _{ob}	$V_{CB} = 4V, I_E = 0, f = 1MHz$		0.9	1.1	pF
Common emitter reverse transfer capacitance	C _{rb}	$V_{CB} = 4V, I_{E} = 0, f = 1MHz$		0.25	0.35	pF
Base time constant	$r_{bb}' \cdot C_C$	$V_{CB} = 4V$, $I_E = -5mA$, $f = 31.9MHz$		11.8	13.5	ps
h _{FE} ratio	h _{FE(RATIO)}	$V_{CE} = 2.4 \text{V}, I_{C} = 100 \mu\text{A}$	0.75		1.6	
		$V_{CE} = 2.4 \text{V}, I_{C} = 7.2 \text{mA}$	0.75			

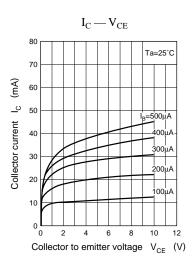
*1h_{FE} Rank classification

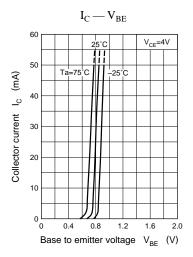
Rank	P	Q
h_{FE}	75 ~ 130	110 ~ 220

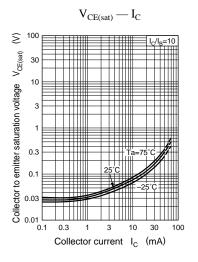
Panasonic

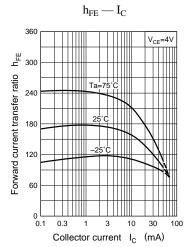
Transistor 2SC3935

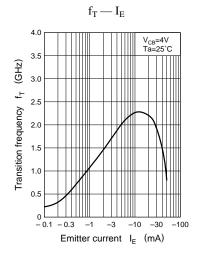


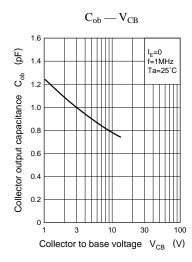












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